

PSE Technology Corporation

SPECIFICATION FOR APPROVAL

CUSTOMER	
NOMINAL FREQUENCY	40.000000 MHz
PRODUCT TYPE	TYPE FH 2.5x2.0 SEAM SEALED CRYSTAL
PART NUMBER	FH4000074Z
CUSTOMER P/N	
ISSUE DATE	March 6, 2015
VERSION	A

APPROVED	PREPARED	QA		
Brenda	Niklai Lu	Dong Jang		
APPROVED BY CUSTOMER				

Please return one copy with approval to PSE-TW

PSE Technology Corporation

No.2, Tzu-Chiang 5th Rd., Chung Li Industrial Park, Chung Li City, Taoyuan County, Taiwan (R.O.C.) TEL:886-3-451-8888 FAX:886-3-461-3865 http://www.saronix-ecera.com.tw/

- *Pb-free
- *RoHS Compliant
- *HF-Halogen Free
- *REACH Compliant

A Company of PERICOM Semiconductor Corporation

E0-R-4-014 Rev.E

VER.A 06-MAR-15

VERSION HISTORY

Version No.	Version Date	Customer Receipt Date	Supplier Receipt Date	Description	Notes
Α	Mar. 6, 2015			Initial Release	

VER.A 06-MAR-15

ELECTRICAL SPECIFICATIONS

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	40.000000	MHz	
Mode of Oscillation	МО	AT Cut-Fundamental		
Calibration Load Capacitance	CL	8	pF	
Calibration Tolerance	FL	± 10	ppm	at 25°C±3°C
Operating Temperature Range	TR	-30 to +85	°C	
Frequency Stability(Frequency Deviation over the Operating Temperature Range)	F/T	± 10	ppm	Reference to the Frequency at 25°C
Operating Drive Level		100	μW	
Maximum Drive Level		150	μW	
Equivalent Series Resistance	ESR	30	Ω	Max.
Equivalent Series Resistance		10	Ω	Тур.
Shunt Capacitance	C0	3	pF	Max.
Aging at 25°C		± 1	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	ΜΩ	Min

^{**} This product doesn"t include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).

VER.A 06-MAR-15

RELIABILITY SPECIFICATIONS

MECHANICAL AND ENVIRONMENTAL RATINGS:

a)FINE LEAK TEST: JESD22-A109 (Condition 1A)

b)GROSS LEAK TEST: JESD22-A109 (Condition C)

c)MOISTURE RESISTANCE: JESD22-A113

d)SHOCK: JESD22-B104 (Condition B)

e)SOLDERABILITY: (RoHS version): J-STD-002

f)VIBRATION: JESD22-B103

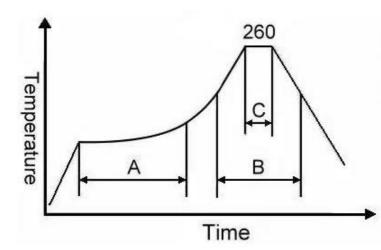
g)SOLVENT RESISTANCE: JESD22-B107

h)RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

Note:

SUGGESTED IR REFLOW PROFILE

*As per IPC-JEDEC J-STD-020D



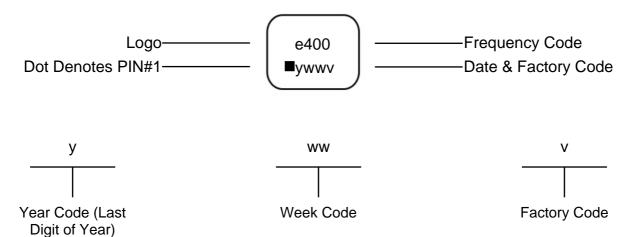
	Stage	Temperature	Time
Α	Preheat	150~200°C	60~120 Sec
В	Primary Heat	217°C	60~150 Sec
0	Dook	ognee	10 900

For soldering reflow profile and reliability test ratings go to: http://www.pericom.com/pdf/sre/reflow.pdf

E0-R-4-014 Rev.E

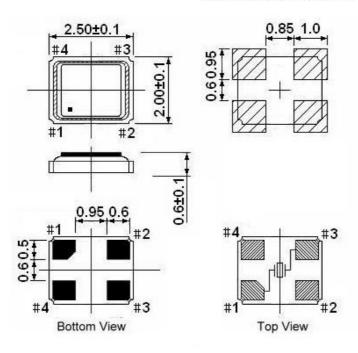
VER.A 06-MAR-15

MARKING



MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)

Recommended Land Pattern



** Recommended - Pin 1 & 3 : CRYSTAL Pin 2 & 4 : GND

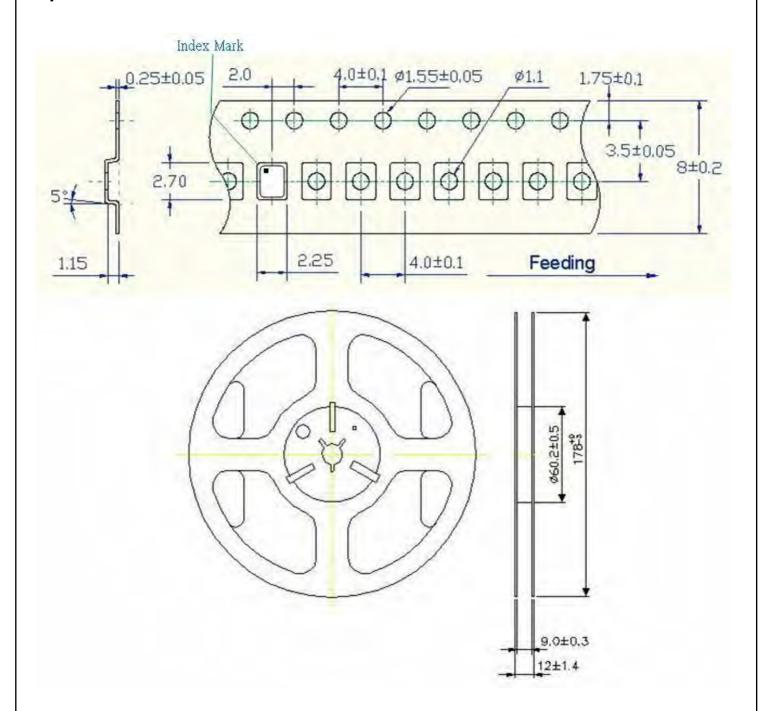
Notes:

- Package drawings are for reference only, and the appearances of objects may vary.
 Actual packages are based on the real product.
- 2. The marking dot denotes Pin#1.
- 3. The position and shape of the chamfer pin may vary and are based on the real product.

E0-R-4-014 Rev.E Page 3

VER.A 06-MAR-15

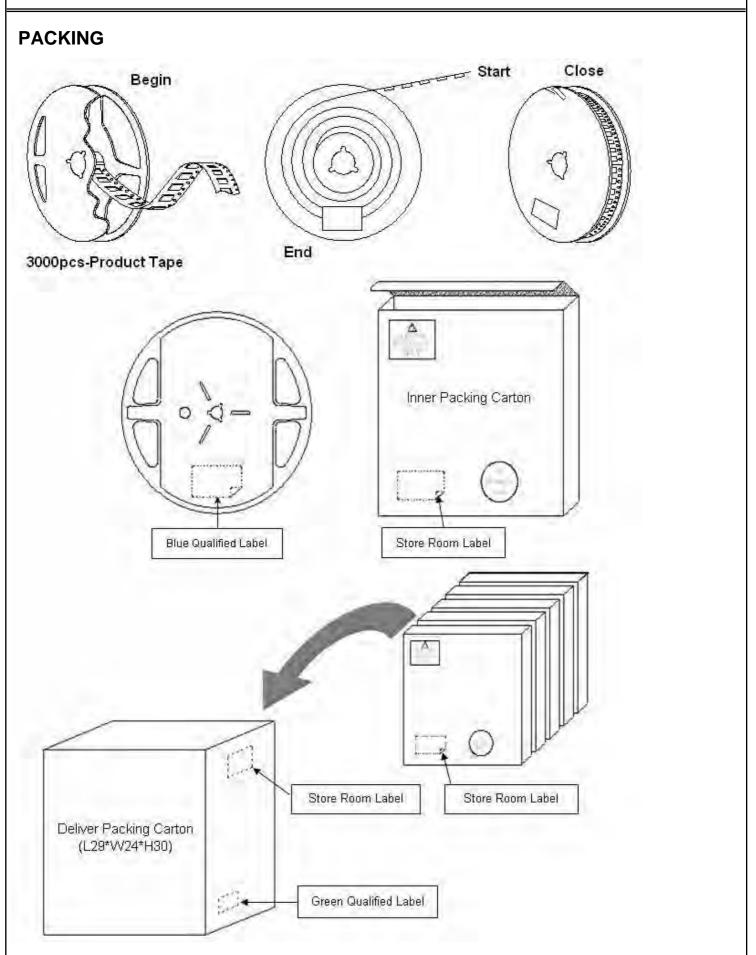
Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

E0-R-4-014 Rev.E Page 4

VER.A 06-MAR-15



E0-R-4-014 Rev.E Page 5

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Diodes Incorporated: FH4000074Z